

## Silicon Carbide Power Schottky Diode

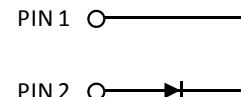
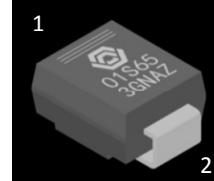
### Features

- 650 V Schottky rectifier
- 175 °C maximum operating temperature
- Temperature independent switching behavior
- Superior surge current capability
- Positive temperature coefficient of  $V_F$
- Extremely fast switching speeds
- Superior figure of merit  $Q_C/I_F$

$V_{RRM}$	=	650 V
$I_F (T_c = 25^\circ C)$	=	2.5 A
$Q_C$	=	7 nC

### Package

- RoHS Compliant



DO – 214AA

### Advantages

- Improved circuit efficiency (Lower overall cost)
- Low switching losses
- Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Low reverse recovery current
- Low device capacitance
- Low reverse leakage current at operating temperature

### Applications

- Power Factor Correction (PFC)
- Switched-Mode Power Supply (SMPS)
- Solar Inverters
- Wind Turbine Inverters
- Motor Drives
- Induction Heating
- Uninterruptible Power Supply (UPS)
- High Voltage Multipliers

### Maximum Ratings at $T_j = 175^\circ C$ , unless otherwise specified

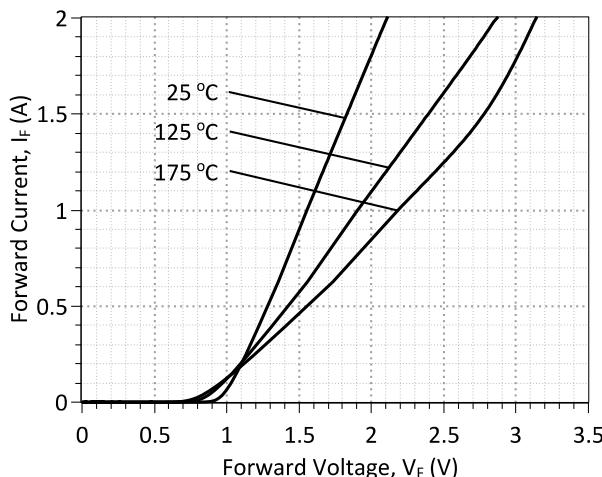
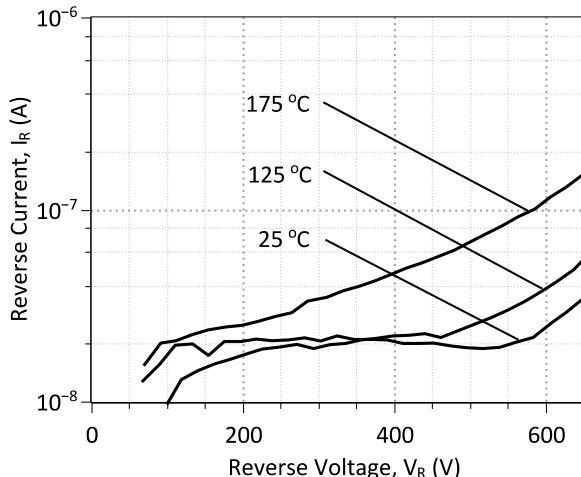
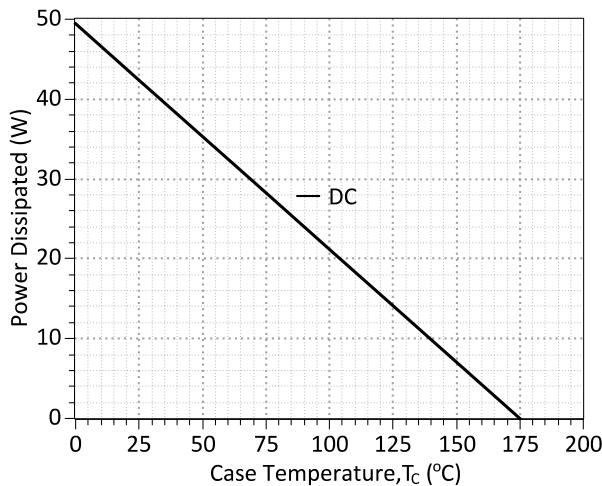
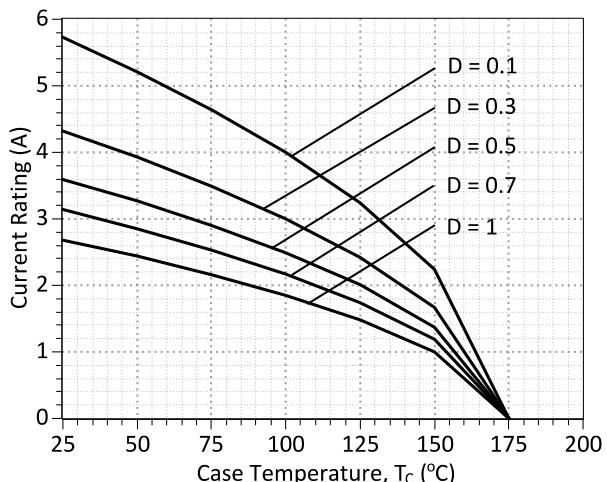
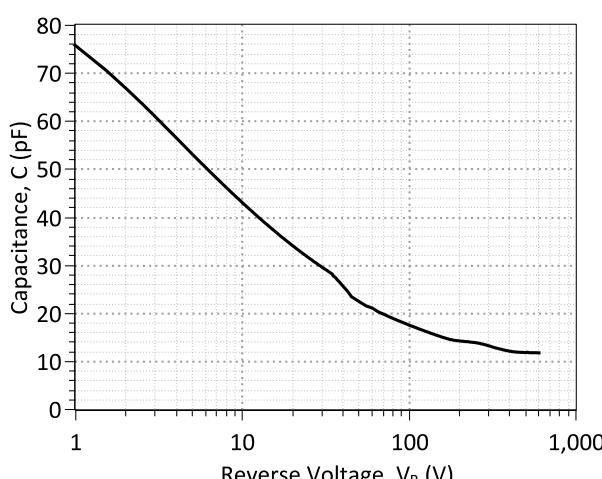
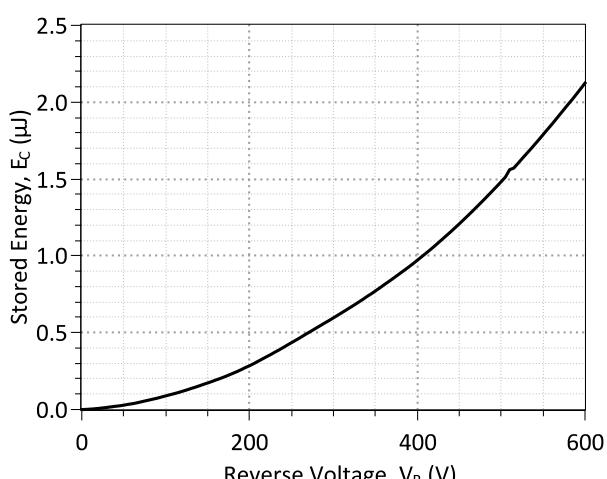
Parameter	Symbol	Conditions	Values	Unit
Repetitive peak reverse voltage	$V_{RRM}$		650	V
Continuous forward current	$I_F$	$T_c \leq 160^\circ C$	1	A
RMS forward current	$I_{F(RMS)}$	$T_c \leq 160^\circ C$	2	A
Surge non-repetitive forward current, Half Sine Wave	$I_{F,SM}$	$T_c = 25^\circ C, t_p = 10 \text{ ms}$	10	A
Non-repetitive peak forward current	$I_{F,max}$	$T_c = 25^\circ C, t_p = 10 \mu\text{s}$	65	A
$I^2t$ value	$\int I^2 dt$	$T_c = 25^\circ C, t_p = 10 \text{ ms}$	0.5	$\text{A}^2\text{s}$
Power dissipation	$P_{tot}$	$T_c = 25^\circ C$	64	W
Operating and storage temperature	$T_j, T_{stg}$		-55 to 175	$^\circ C$

### Electrical Characteristics at $T_j = 175^\circ C$ , unless otherwise specified

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Diode forward voltage	$V_F$	$I_F = 1 \text{ A}, T_j = 25^\circ C$	1.5	2.0	2.3	V
		$I_F = 1 \text{ A}, T_j = 175^\circ C$			3.0	
Reverse current	$I_R$	$V_R = 650 \text{ V}, T_j = 25^\circ C$	1	10	5	$\mu\text{A}$
		$V_R = 650 \text{ V}, T_j = 175^\circ C$			50	
Total capacitive charge	$Q_C$	$I_F \leq I_{F,MAX}$	7			nC
Switching time	$t_s$	$dI_F/dt = 200 \text{ A}/\mu\text{s}$	$V_R = 400 \text{ V}$	< 20		ns
		$T_j = 175^\circ C$	$V_R = 400 \text{ V}$			
Total capacitance	$C$	$V_R = 1 \text{ V}, f = 1 \text{ MHz}, T_j = 25^\circ C$	76			pF
		$V_R = 400 \text{ V}, f = 1 \text{ MHz}, T_j = 25^\circ C$	12			

### Thermal Characteristics

Thermal resistance, junction - case	$R_{thJC}$	3.55	$^\circ C/W$
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**Figure 1: Typical Forward Characteristics**

**Figure 2: Typical Reverse Characteristics**

**Figure 3: Power Derating Curve**

**Figure 4: Current Derating Curves ( $D = t_p/T$ ,  $t_p = 400 \mu s$ )  
(Considering worst case  $Z_{th}$  conditions )**

**Figure 5: Typical Junction Capacitance vs Reverse Voltage Characteristics**

**Figure 6: Typical Switching Energy vs Reverse Voltage Characteristics**

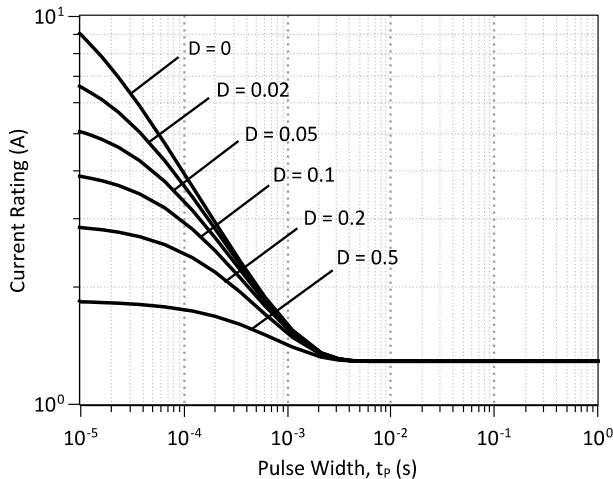


Figure 7: Current vs Pulse Duration Curves at  $T_c = 160 \text{ } ^\circ\text{C}$

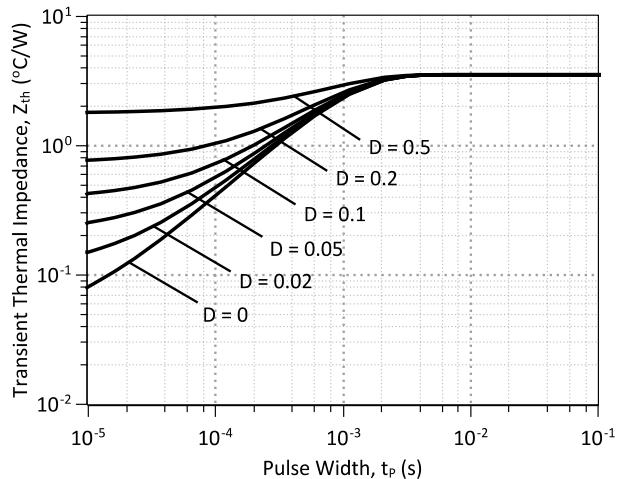
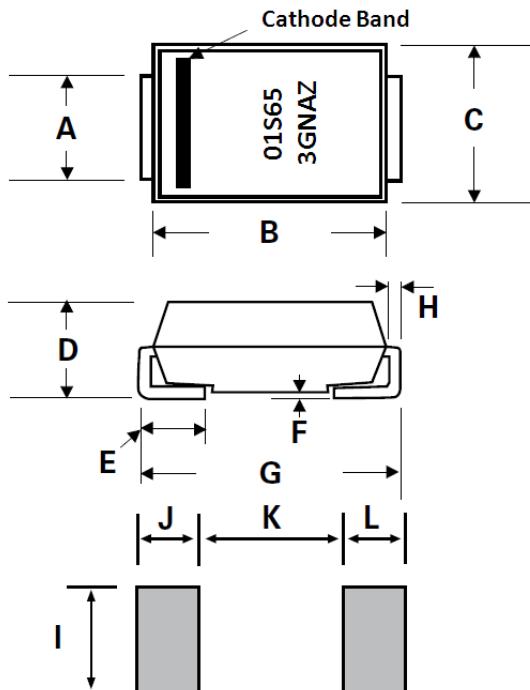


Figure 8: Transient Thermal Impedance

### Package Dimensions:

DO-214AA



PACKAGE OUTLINE

Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.077	0.086	1.950	2.200
B	0.160	0.180	4.060	4.570
C	0.130	0.155	3.300	3.940
D	0.084	0.096	2.130	2.440
E	0.030	0.060	0.760	1.520
F	-	0.008	-	0.203
G	0.205	0.220	5.210	5.590
H	0.006	0.012	0.152	0.305
I	0.089	-	2.260	-
J	0.085	-	2.160	-
K	-	0.107	-	2.740
L	0.085	-	2.160	-

### NOTE

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS

<b>Revision History</b>			
Date	Revision	Comments	Supersedes
2014/08/26	1	Updated Electrical Characteristics	
2013/09/09	0	Initial release	

## Published by

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## SPICE Model Parameters

Copy the following code into a SPICE software program for simulation of the GB01SLT06-214 device.

```
* MODEL OF GeneSiC Semiconductor Inc.  
*  
* $Revision: 1.0      $  
* $Date: 09-SEP-2013 $  
*  
* GeneSiC Semiconductor Inc.  
* 43670 Trade Center Place Ste. 155  
* Dulles, VA 20166  
* http://www.genesicsemi.com/index.php/sic-products/schottky  
*  
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* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY  
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED  
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A  
* PARTICULAR PURPOSE."  
* Models accurate up to 2 times rated drain current.  
*  
* Start of GB01SLT06-214 SPICE Model  
*  
.SUBCKT GB01SLT06 ANODE KATHODE  
D1 ANODE KATHODE GB01SLT06_25C; Call the Schottky Diode Model  
D2 ANODE KATHODE GB01SLT06_PIN; Call the PiN Diode Model  
.MODEL GB01SLT06_25C D  
+ IS      3.57E-18      RS      0.49751  
+ TRS1    0.0057      TRS2    2.40E-05  
+ N       1            IKF     322  
+ EG      1.2          XTI     3  
+ CJO     9.12E-11     VJ      0.371817384  
+ M       1.527759838   FC      0.5  
+ TT      1.00E-10     BV      650  
+ IBV     1.00E-03     VPK     650  
+ IAVE    1            TYPE    Sic_Schottky  
+ MFG     GeneSiC_Semiconductor  
.MODEL GB01SLT06_PIN D  
+ IS      5.73E-11      RS      0.72994  
+ N       5            IKF     800  
+ EG      3.23         XTI     -14  
+ FC      0.5          TT      0  
+ BV      650          IBV     1.00E-03  
+ VPK     650          IAVE    1  
+ TYPE    Sic_Pin  
.ENDS  
*  
* End of GB01SLT06-214 SPICE Model
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